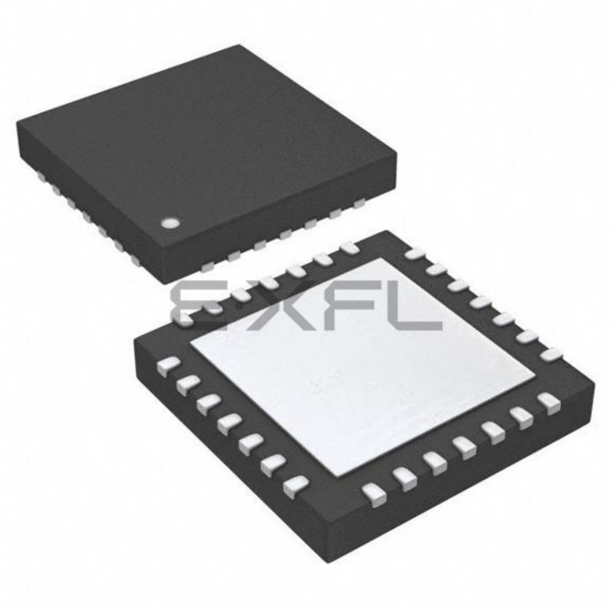

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 20x12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-UFQFN Exposed Pad
Supplier Device Package	28-UQFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f19155-i-mv

TABLE 4-11: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 (ALL BANKS)

Bank Offset Bank 0-Bank 63	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
All Banks											
x00h or x80h	INDF0	INDF0								xxxx xxxx	xxxx xxxx
x01h or x81h	INDF1	INDF1								xxxx xxxx	xxxx xxxx
x02h or x82h	PCL	PCL								0000 0000	0000 0000
x03h or x83h	STATUS	—	—	—	$\overline{TO}$	$\overline{PD}$	Z	DC	C	---1 1000	---q quuu
x04h or x84h	FSR0L	FSR0L								0000 0000	uuuu uuuu
x05h or x85h	FSR0H	FSR0H								0000 0000	0000 0000
x06h or x86h	FSR1L	FSR1L								0000 0000	uuuu uuuu
x07h or x87h	FSR1H	FSR1H								0000 0000	0000 0000
x08h or x88h	BSR	—	—	BSR						--00 0000	--00 0000
x09h or x89h	WREG	WREG0								0000 0000	uuuu uuuu
x0Ah or x8Ah	PCLATH	—	PCLATH							-000 0000	-000 0000
x0Bh or x8Bh	INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	00-- ---1	00-- ---1

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

Note 1: These Registers can be accessed from any bank

REGISTER 8-3: PCON1: POWER CONTROL REGISTER 1

U-0	U-0	U-0	U-0	U-0	U-0	R/W/HC-1/u	R/W/HC-q/u
—	—	—	—	—	—	$\overline{\text{MEMV}}$	$\overline{\text{VBATBOR}}$
bit 7							bit 0

Legend:		
HC = Bit is cleared by hardware		HS = Bit is set by hardware
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-m/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-2 **Unimplemented:** Read as ‘0’.

bit 1 **$\overline{\text{MEMV}}$:** Memory Violation Flag bit
1 = No Memory Violation Reset occurred or set to ‘1’ by firmware
0 = A Memory Violation Reset occurred (set ‘0’ in hardware when a Memory Violation occurs)

bit 0 **$\overline{\text{VBATBOR}}$:** VBAT Brown-Out Reset Status Bit
1 = No VBAT Brown-out Reset occurred.
0 = A VBAT Brown-out Reset occurred.

8.17 VBAT System

The VBAT subsystem allows the RTCC and SOSC to run from a battery connected to the VBAT pin in the event of a VDD failure. Typically, the battery is a 3V coin cell, however the system is designed to operate over the entire VDD voltage range. If VDD is greater than VBAT, the RTCC and SOSC will be powered by VDD. If VDD is less than VBAT, the RTCC and SOSC will switch over to VBAT. See Table 4-5 and Table 4-8 for more information on the VBAT registers.

> **Note:** It should be noted that in this second scenario, VDD may still be in the valid operating range, but anytime the VDD drops below VBAT, the RTCC and SOSC will switch over to VBAT. This means that in a system with a 3V battery and a 2.8V VDD, the RTCC and SOSC will run off VBAT even when VDD is present.

8.17.1 VBAT GPR SEMAPHORE REGISTERS

The VBAT voltage domain offers the user four registers: VB0GPR, VB1GPR, VB3GPR and VB4GPR. These registers can be used by firmware to write any information that needs to survive a VDD failure. As long as either VDD or VBAT is valid, these registers will hold the last value written.

9.2 Clock Source Types

Clock sources can be classified as external or internal.

External clock sources rely on external circuitry for the clock source to function. Examples are: oscillator modules (ECH, ECM, ECL mode).

Internal clock sources are contained within the oscillator module. The internal oscillator block has two internal oscillators and a dedicated Phase Lock Loop (PLL) that are used to generate internal system clock sources. The High-Frequency Internal Oscillator (HFINTOSC) can produce a range from 1 to 32 MHz. The Low-Frequency Internal Oscillator (LFINTOSC) generates a 31 kHz frequency. The external oscillator block can also be used with the PLL.

The system clock can be selected between external or internal clock sources via the NOSC bits in the OSCCON1 register. See **Section 9.3 "Clock Switching"** for additional information.

9.2.1 EXTERNAL CLOCK SOURCES

An external clock source can be used as the device system clock by performing one of the following actions:

- Program the RSTOSC<2:0> bits in the Configuration Words to select an external clock source that will be used as the default system clock upon a device Reset
- Write the NOSC<2:0> and NDIV<3:0> bits in the OSCCON1 register to switch the system clock source

See **Section 9.3 "Clock Switching"** for more information.

9.2.1.1 EC Mode

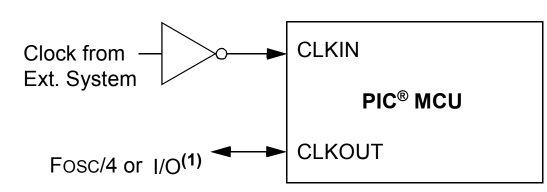
The External Clock (EC) mode allows an externally generated logic level signal to be the system clock source. When operating in this mode, an external clock source is connected to the CLKIN input. CLKOUT is available for general purpose I/O or CLKOUT. Figure 9-2 shows the pin connections for EC mode.

EC mode has three power modes to select from through Configuration Words:

- ECH – High power, < = 32 MHz
- ECM – Medium power, < = 8 MHz
- ECL – Low power, < = 0.5 MHz

The Oscillator Start-up Timer (OST) is disabled when EC mode is selected. Therefore, there is no delay in operation after a Power-on Reset (POR) or wake-up from Sleep. Because the PIC® MCU design is fully static, stopping the external clock input will have the effect of halting the device while leaving all data intact. Upon restarting the external clock, the device will resume operation as if no time had elapsed.

FIGURE 9-2: EXTERNAL CLOCK (EC) MODE OPERATION

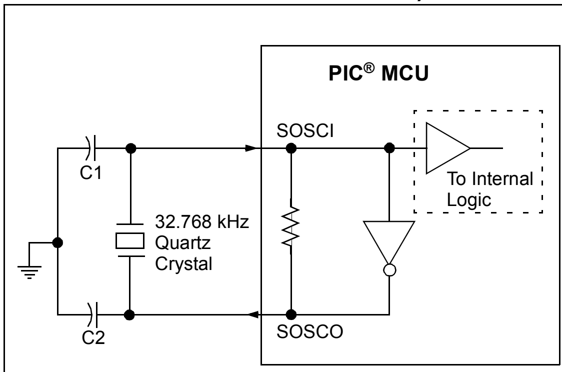


Note 1: Output depends upon $\overline{\text{CLKOUTEN}}$ bit of the Configuration Words.

9.2.1.2 Secondary Oscillator

The secondary oscillator is a separate oscillator block that can be used as an alternate system clock source. The secondary oscillator is optimized for 32.768 kHz, and can be used with an external crystal oscillator connected to the SOSCI and SOSCO device pins, or an external clock source connected to the SOSCI pin. Refer to **Section 9.3 "Clock Switching"** for more information.

FIGURE 9-3: QUARTZ CRYSTAL OPERATION (SECONDARY OSCILLATOR)



REGISTER 10-18: PIR7: PERIPHERAL INTERRUPT REQUEST REGISTER 7

U-0	U-0	R/W/HS-0/0	U-0	U-0	U-0	U-0	R/W/HS-0/0
—	—	NVMIF	—	—	—	—	CWG1IF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HS = Hardware set

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5 **NVMIF:** Nonvolatile Memory (NVM) Interrupt Flag bit
1 = The requested NVM operation has completed
0 = NVM interrupt not asserted

bit 4-1 **Unimplemented:** Read as ‘0’

bit 0 **CWG1IF:** CWG1 Interrupt Flag bit
1 = CWG1 has gone into shutdown
0 = CWG1 is operating normally, or interrupt cleared

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 14-24: INLVLC: PORTC INPUT LEVEL CONTROL REGISTER

R/W-1/1	R/W-1/1	U-0	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
INLVLC7	INLVLC6	—	INLVLC4	INLVLC3	INLVLC2	INLVLC1	INLVLC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **INLVLC<7:6>:** PORTC Input Level Select bits
For RC<7:6> pins, respectively
1 = ST input used for PORT reads and interrupt-on-change
0 = TTL input used for PORT reads and interrupt-on-change

bit 5 **Unimplemented:** Read as ‘0’.

bit 4-0 **INLVLC<4:0>:** PORTC Input Level Select bits
For RC<4:0> pins, respectively
1 = ST input used for PORT reads and interrupt-on-change
0 = TTL input used for PORT reads and interrupt-on-change

TABLE 14-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
PORTC	RC7	RC6	—	RC4	RC3	RC2	RC1	RC0	235
TRISC	TRISC7	TRISC6	—	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	235
LATC	LATC7	LATC6	—	LATC4	LATC3	LATC2	LATC1	LATC0	236
WPUC	WPUC7	WPUC6	—	WPUC4	WPUC3	WPUC2	WPUC1	WPUC0	236
ODCONC	ODCC7	ODCC6	—	ODCC4	ODCC3	ODCC2	ODCC1	ODCC0	237
SLRCONC	SLRC7	SLRC6	—	SLRC4	SLRC3	SLRC2	SLRC1	SLRC0	237
INLVLC	INLVLC7	INLVLC6	—	INLVLC4	INLVLC3	INLVLC2	INLVLC1	INLVLC0	238

Legend: – = unimplemented locations read as ‘0’. Shaded cells are not used by PORTC.

REGISTER 17-7: IOCCP: INTERRUPT-ON-CHANGE PORTC POSITIVE EDGE REGISTER

R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCCP7	IOCCP6	—	IOCCP4	IOCCP3	IOCCP2	IOCCP1	IOCCP0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **IOCCP<7:6>:** Interrupt-on-Change PORTC Positive Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a positive-going edge. IOCCFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

bit 5 **Unimplemented:** Read as ‘0’

bit 4-0 **IOCCP<4:0>:** Interrupt-on-Change PORTC Positive Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a positive-going edge. IOCCFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

REGISTER 17-8: IOCCN: INTERRUPT-ON-CHANGE PORTC NEGATIVE EDGE REGISTER

R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCCN7	IOCCN6	—	IOCCN4	IOCCN3	IOCCN2	IOCCN1	IOCCN0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **IOCCN<7:6>:** Interrupt-on-Change PORTC Negative Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a negative-going edge. IOCCFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

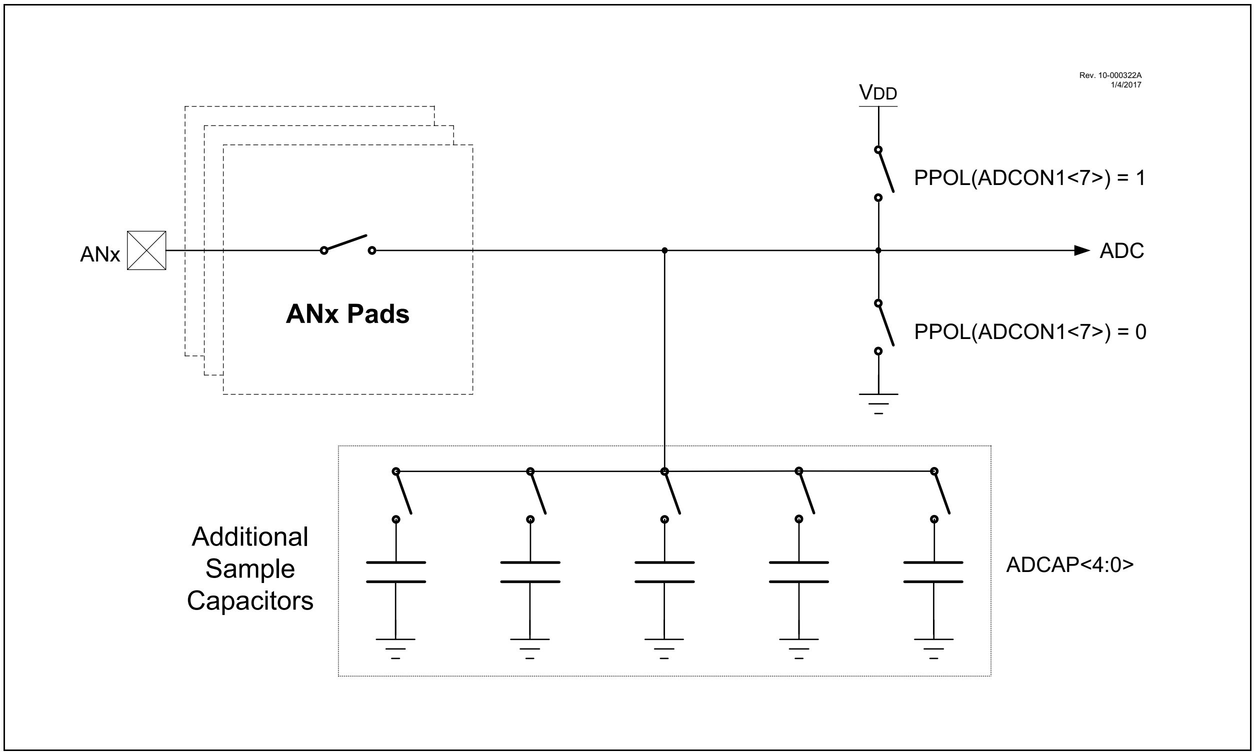
bit 5 **Unimplemented:** Read as ‘0’

bit 4-0 **IOCCN<4:0>:** Interrupt-on-Change PORTC Negative Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a negative-going edge. IOCCFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

19.4 Capacitive Voltage Divider (CVD) Features

The ADC module contains several features that allow the user to perform a relative capacitance measurement on any ADC channel using the internal ADC sample and hold capacitance as a reference. This relative capacitance measurement can be used to implement capacitive touch or proximity sensing applications. Figure 19-6 shows the basic block diagram of the CVD portion of the ADC module.

FIGURE 19-6: HARDWARE CAPACITIVE VOLTAGE DIVIDER BLOCK DIAGRAM



REGISTER 19-24: ADACCU: ADC ACCUMULATOR REGISTER UPPER

U-0	U-0	U-0	U-0	U-0	U-0	R/W-x/x	R/W-x/x
—	—	—	—	—	—	ACC<17:16>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-2 **Unimplemented**: Read as '0'

bit 1-0 **ACC<17:16>**: ADC Accumulator MSB. Upper two bits of accumulator value. See Table 19-2 for more details.

REGISTER 19-25: ADACCH: ADC ACCUMULATOR REGISTER HIGH

R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x
ACC<15:8>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **ACC<15:8>**: ADC Accumulator middle bits. Middle eight bits of accumulator value. See Table 19-2 for more details.

REGISTER 19-26: ADACCL: ADC ACCUMULATOR REGISTER LOW

R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x
ACC<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **ACC<7:0>**: ADC Accumulator LSB. Lower eight bits of accumulator value. See Table 19-2 for more details.

REGISTER 19-36: ADCP: ADC CHARGE PUMP CONTROL REGISTER

R/W-0/0	U-0	U-0	U-0	U-0	U-0	U-0	R-0/0
CPON	—	—	—	—	—	—	CPRDY
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS= Hardware set

bit 7 **CPON**: Charge Pump On Control bit
1 = Charge Pump On when requested by the ADC
0 = Charge Pump Off

bit 6-1 **Unimplemented:** Read as '0'

bit 0 CPRDY: Charge Pump Ready Status bit
1 = Charge Pump is ready
0 = Charge Pump is not ready (or never started)

22.4 Comparator Hysteresis

A selectable amount of separation voltage can be added to the input pins of each comparator to provide a hysteresis function to the overall operation. Hysteresis is enabled by setting the CxHYS bit of the CMxCON0 register.

See Comparator Specifications in Table 39-14 for more information.

22.5 Timer1 Gate Operation

The output resulting from a comparator operation can be used as a source for gate control of Timer1. See **Section 26.0 "Timer1 Module with Gate Control"** for more information. This feature is useful for timing the duration or interval of an analog event.

It is recommended that the comparator output be synchronized to Timer1 by setting CMxCON0.SYNC = 1.

22.5.1 COMPARATOR OUTPUT SYNCHRONIZATION

The output from a comparator can be synchronized with Timer1 by setting the CxSYNC bit of the CMxCON0 register.

Once enabled, the comparator output is latched on the falling edge of the Timer1 source clock. If a prescaler is used with Timer1, the comparator output is latched after the prescaling function. To prevent a race condition, the comparator output is latched on the falling edge of the Timer1 clock source and Timer1 increments on the rising edge of its clock source. See the Comparator Block Diagram (Figure 22-2) and the Timer1 Block Diagram (Figure 26-1) for more information.

22.6 Comparator Interrupt

An interrupt can be generated upon a change in the output value of the comparator for each comparator, a rising edge detector and a falling edge detector are present.

When either edge detector is triggered and its associated enable bit is set (CxINTP and/or CxINTN bits of the CMxCON1 register), the Corresponding Interrupt Flag bit (CxIF bit of the PIR2 register) will be set.

To enable the interrupt, you must set the following bits:

- CxON, CxPOL and CxSP bits of the CMxCON0 register
- CxIE bit of the PIE2 register
- CxINTP bit of the CMxCON1 register (for a rising edge detection)
- CxINTN bit of the CMxCON1 register (for a falling edge detection)
- PEIE and GIE bits of the INTCON register

The associated interrupt flag bit, CxIF bit of the PIR2 register, must be cleared in software. If another edge is detected while this flag is being cleared, the flag will still be set at the end of the sequence.

Note:	Although a comparator is disabled, an interrupt can be generated by changing the output polarity with the CxPOL bit of the CMxCON0 register, or by switching the comparator on or off with the CxON bit of the CMxCON0 register.

22.7 Comparator Positive Input Selection

Configuring the CxPCH<2:0> bits of the CMxPSEL register directs an internal voltage reference or an analog pin to the noninverting input of the comparator:

- CxIN0+ analog pin
- DAC output
- FVR (Fixed Voltage Reference)
- VSS (Ground)

See **Section 18.0 "Fixed Voltage Reference (FVR)"** for more information on the Fixed Voltage Reference module.

See **Section 21.0 "5-Bit Digital-to-Analog Converter (DAC1) Module"** for more information on the DAC input signal.

Any time the comparator is disabled (CxON = 0), all comparator inputs are disabled.

22.8 Comparator Negative Input Selection

The CxNCH<2:0> bits of the CMxCON1 register direct an analog input pin and internal reference voltage or analog ground to the inverting input of the comparator:

- CxIN- pin
- FVR (Fixed Voltage Reference)
- Analog Ground

Note:	To use CxINy+ and CxINy- pins as analog input, the appropriate bits must be set in the ANSEL register and the corresponding TRIS bits must also be set to disable the output drivers.

REGISTER 22-5: CMOUT: COMPARATOR OUTPUT REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	R-0/0	R-0/0
—	—	—	—	—	—	MC2OUT	MC1OUT
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-2 **Unimplemented:** Read as ‘0’

bit 1 **MC2OUT:** Mirror Copy of C2OUT bit

bit 0 **MC1OUT:** Mirror Copy of C1OUT bit

TABLE 22-3: SUMMARY OF REGISTERS ASSOCIATED WITH COMPARATOR MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
CMxCON0	ON	OUT	—	POL	—	—	HYS	SYNC	340
CMxCON1	—	—	—	—	—	—	INTP	INTN	341
CMOUT	—	—	—	—	—	—	MC2OUT	MC1OUT	343
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFVR<1:0>		ADFVR<1:0>		285
DAC1CON0	DAC1EN	—	DAC1OE1	DAC1OE2	DAC1PSS<1:0>		—	—	332
DAC1CON1	—	—	—	DAC1R<4:0>					332
INTCON	GIE	PEIE	—					INTEDG	164
PIE2	—	ZCDIE	—	—	—	—	C2IE	C1IE	167
PIR2	—	ZCDIF	—	—	—	—	C2IF	C1IF	176
CLCINxPPS	—	—	—	CLCIN0PPS<4:0>					264
T1GPPS	—	—	—	T1GPPS<4:0>					264

Legend: — = unimplemented location, read as ‘0’. Shaded cells are unused by the comparator module.

EQUATION 23-2: R-C CALCULATIONS

V_{peak} = external voltage source peak voltage
f = external voltage source frequency
C = series capacitor
R = series resistor
V_C = Peak capacitor voltage
ϕ = Capacitor induced zero crossing phase advance in radians
T_ϕ = Time ZC event occurs before actual zero crossing

$$Z = \frac{V_{PEAK}}{3x10^{-4}}$$

$$X_C = \frac{1}{(2\pi fC)}$$

$$R = \sqrt{Z^2 - X_C}$$

$$V_C = X_C(3x10^{-4})$$

$$\phi = Tan^{-1}\left(\frac{X_C}{R}\right)$$

$$T_\phi = \frac{\phi}{(2\pi f)}$$

V_{rms} = 120

EXAMPLE 23-1: R-C CALCULATIONS EXAMPLE

$$V_{peak} = V_{rms} \cdot \sqrt{2} = 169.7$$

f = 60 Hz
C = 0.1 μf

$$Z = \frac{V_{peak}}{3 \times 10^{-4}} = \frac{169.7}{3 \times 10^{-4}} = 565.7\ kOhms$$

$$X_C = \frac{1}{(2\pi fC)} = \frac{1}{(2\pi \cdot 60 \cdot 1 \cdot 10^{-7})} = 26.53\ \text{kOhms}$$

R = 560 kOhms

$$Z_R = \sqrt{(R^2 + X_c{}^2)} = 560.6\ kOhm\ \text{(using actual resistor)}$$

$$I_{peak} = \frac{V_{peak}}{Z_R} = 302.7 \cdot 10^{-6}$$

$$V_C = X_C \cdot I_{peak} = 8.0\ \text{V}$$

$$\phi = Tan^{-1}\left(\frac{X_C}{R}\right) = 0.047\ radians$$

$$T_\phi = \frac{\phi}{(2\pi f)} = 125.6\ \mu s$$

TABLE 24-2: DAY TO MONTH ROLLOVER SCHEDULE

Month	Maximum Day Field
01 (January)	31
02 (February)	28 or 29(1)
03 (March)	31
04 (April)	30
05 (May)	31
06 (June)	30
07 (July)	31
08 (August)	31
09 (September)	30
10 (October)	31
11 (November)	30
12 (December)	31

Note 1: See **Section 24.1.5 "Leap Year"**.

24.1.5 LEAP YEAR

Since the year range on the RTCC module is 2000 to 2099, the leap year calculation is determined by any year divisible by four in the above range. Only February is effected in a leap year.

February will have 29 days in a leap year and 28 days in any other year.

> **Note:** The corresponding counters are clocked based on their defined intervals (i.e., the DAYS register is clocked once a day, the MONTHS register is only clocked once a month, etc.). This leaves large windows of time during which registers can be safely updated.

24.1.6 SAFETY WINDOW FOR REGISTER READS AND WRITES

The RTCSYNC bit indicates a time window during which the RTCC Clock Domain registers (see Figure 24-1) can be safely read and written without concern about a rollover. When RTCSYNC = 0, the registers can be safely accessed by the CPU.

Whether RTCSYNC = 1 or 0, the user should employ a firmware solution to ensure that the data read did not fall on a rollover boundary, resulting in an invalid or partial read. This firmware solution would consist of reading each register twice and then comparing the two values. If the two values matched, then, a rollover did not occur.

The Status bit is set a number of clock edges before a rollover is about to occur, as follows:

- RTCCLKSEL<1:0> = 00: 32 SOSC clock cycles
- RTCCLKSEL<1:0> = 01: 32 MFINTOSC/16 clock cycles
- RTCCLKSEL<1:0> = 10: 1 50 Hz clock cycle (ZCD)
- RTCCLKSEL<1:0> = 11: 1 60 Hz clock cycle (ZCD)

The RTCSYNC bit is cleared at the time the rollover occurs. Assuming that the device uses the 32.768 kHz oscillator as the device clock (RTCCLKSEL<1:0> = 00), the 32 clock edges allow execution of approximately 1 millisecond following a read of the RTCSYNC of '0' (a period of time is lost due to bit synchronization).

24.1.7 CALIBRATION

The real-time crystal input can be calibrated using the periodic auto-adjust feature. When properly calibrated, the RTCC can provide an error of less than three seconds per month.

This is accomplished by finding the number of error clock pulses and storing the value into the RTCCAL register. The 8-bit signed value loaded into RTCCAL is multiplied by four and will either be added or subtracted from the RTCC timer, once every minute.

> **Note:** The RTCC 1/2 second clock signal can be brought out to a pin via PPS. See **Section 15.0 "Peripheral Pin Select (PPS) Module"** and Table 15-3.

To calibrate the RTCC module refer to the steps below:

1. The user must first find the error of the timer source being used.
2. Once the error is known, it must be converted to the number of error clock pulses per minute (see Equation 24-1).

EQUATION 24-1: CONVERTING ERROR CLOCK PULSES

*(Ideal Frequency (32,768) – Measured Frequency) * 60 =*

= Error Clocks per Minute

- If the oscillator is *faster* than ideal (negative result from Step 2), the RTCCAL register value needs to be negative. This causes the specified number of clock pulses to be subtracted from the timer counter, once every minute.
- If the oscillator is *slower* than ideal (positive result from Step 2), the RTCCAL register value needs to be positive. This causes the specified number of clock pulses to be added to the timer counter, once every minute.

3. Load the RTCCAL register with the value.

26.1 Timer1 Operation

The Timer1 modules are 16-bit incrementing counters which are accessed through the TMR1H:TMR1L register pairs. Writes to TMR1H or TMR1L directly update the counter.

When used with an internal clock source, the module is a timer and increments on every instruction cycle. When used with an external clock source, the module can be used as either a timer or counter and increments on every selected edge of the external source.

The timer is enabled by configuring the TMR1ON and GE bits in the T1CON and T1GCON registers, respectively. Table 26-1 displays the Timer1 enable selections.

TABLE 26-1: TIMER1 ENABLE SELECTIONS

TMR1ON	TMR1GE	Timer1 Operation
1	1	Count Enabled
1	0	Always On
0	1	Off
0	0	Off

26.2 Clock Source Selection

The T1CLK register is used to select the clock source for the timer. Register 26-3 shows the possible clock sources that may be selected to make the timer increment.

26.2.1 INTERNAL CLOCK SOURCE

When the internal clock source FOSC is selected, the TMR1H:TMR1L register pair will increment on multiples of FOSC as determined by the respective Timer1 prescaler.

When the FOSC internal clock source is selected, the timer register value will increment by four counts every instruction clock cycle. Due to this condition, a 2 LSB error in resolution will occur when reading the TMR1H:TMR1L value. To utilize the full resolution of the timer in this mode, an asynchronous input signal must be used to gate the timer clock input.

Out of the total timer gate signal sources, the following subset of sources can be asynchronous and may be useful for this purpose:

- CLC4 output
- CLC3 output
- CLC2 output
- CLC1 output
- Zero-Cross Detect output
- Comparator2 output
- Comparator1 output
- TxG PPS remappable input pin

26.2.2 EXTERNAL CLOCK SOURCE

When the timer is enabled and the external clock input source (ex: T1CKI PPS remappable input) is selected as the clock source, the timer will increment on the rising edge of the external clock input.

When using an external clock source, the timer can be configured to run synchronously or asynchronously, as described in **Section 26.5 "Timer Operation in Asynchronous Counter Mode"**.

When used as a timer with a clock oscillator, an external 32.768 kHz crystal can be used connected to the SOSCI/SOSCO pins.

Note: In Counter mode, a falling edge must be registered by the counter prior to the first incrementing rising edge after any one or more of the following conditions:

- The timer is first enabled after POR
- Firmware writes to TMR1H or TMR1L
- The timer is disabled
- The timer is re-enabled (e.g., TMR1ON-->1) when the T1CKI signal is currently logic low.

26.6.2 TIMER GATE SOURCE SELECTION

One of the several different external or internal signal sources may be chosen to gate the timer and allow the timer to increment. The gate input signal source can be selected based on the T1GATE register setting. See the T1GATE register (Register 26-4) description for a complete list of the available gate sources. The polarity for each available source is also selectable. Polarity selection is controlled by the GPOL bit of the T1GCON register.

26.6.2.1 T1G Pin Gate Operation

The T1G pin is one source for the timer gate control. It can be used to supply an external source to the time gate circuitry.

26.6.2.2 Timer0 Overflow Gate Operation

When Timer0 overflows, or a period register match condition occurs (in 8-bit mode), a low-to-high pulse will automatically be generated and internally supplied to the Timer1 gate circuitry.

26.6.2.3 Comparator C1 Gate Operation

The output resulting from a Comparator 1 operation can be selected as a source for the timer gate control. The Comparator 1 output can be synchronized to the timer clock or left asynchronous. For more information see **Section 22.5.1 "Comparator Output Synchronization"**.

26.6.2.4 Comparator C2 Gate Operation

The output resulting from a Comparator 2 operation can be selected as a source for the timer gate control. The Comparator 2 output can be synchronized to the timer clock or left asynchronous. For more information see **Section 22.5.1 "Comparator Output Synchronization"**.

26.6.3 TIMER1 GATE TOGGLE MODE

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a timer gate signal, as opposed to the duration of a single level pulse.

The timer gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. See Figure 26-4 for timing details.

Timer1 Gate Toggle mode is enabled by setting the GTM bit of the T1GCON register. When the GTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

Note:	Enabling Toggle mode at the same time as changing the gate polarity may result in indeterminate operation.

26.6.4 TIMER1 GATE SINGLE-PULSE MODE

When Timer1 Gate Single-Pulse mode is enabled, it is possible to capture a single-pulse gate event. Timer1 Gate Single-Pulse mode is first enabled by setting the GSPM bit in the T1GCON register. Next, the GGO/$\overline{\text{DONE}}$ bit in the T1GCON register must be set. The timer will be fully enabled on the next incrementing edge. On the next trailing edge of the pulse, the GGO/$\overline{\text{DONE}}$ bit will automatically be cleared. No other gate events will be allowed to increment the timer until the GGO/$\overline{\text{DONE}}$ bit is once again set in software. See Figure 26-5 for timing details.

If the Single-Pulse Gate mode is disabled by clearing the GSPM bit in the T1GCON register, the GGO/$\overline{\text{DONE}}$ bit should also be cleared.

Enabling the Toggle mode and the Single-Pulse mode simultaneously will permit both sections to work together. This allows the cycle times on the timer gate source to be measured. See Figure 26-6 for timing details.

26.6.5 TIMER1 GATE VALUE STATUS

When Timer1 Gate Value Status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the GVAL bit in the T1GCON register. The GVAL bit is valid even when the timer gate is not enabled (GE bit is cleared).

26.6.6 TIMER1 GATE EVENT INTERRUPT

When Timer1 Gate Event Interrupt is enabled, it is possible to generate an interrupt upon the completion of a gate event. When the falling edge of GVAL occurs, the TMR1GIF flag bit in the PIR5 register will be set. If the TMR1GIE bit in the PIE5 register is set, then an interrupt will be recognized.

The TMR1GIF flag bit operates even when the timer gate is not enabled (TMR1GE bit is cleared).

LSLF — Logical Left Shift

Syntax:	[*label*] LSLF f {,d}
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(f<7>) → C (f<6:0>) → dest<7:1> 0 → dest<0>
Status Affected:	C, Z
Description:	The contents of register 'f' are shifted one bit to the left through the Carry flag. A '0' is shifted into the LSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.

LSRF — Logical Right Shift

Syntax:	[*label*] LSRF f {,d}
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	0 → dest<7> (f<7:1>) → dest<6:0>, (f<0>) → C,
Status Affected:	C, Z
Description:	The contents of register 'f' are shifted one bit to the right through the Carry flag. A '0' is shifted into the MSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.

MOVF — Move f

Syntax:	[*label*] MOVF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(f) → (dest)
Status Affected:	Z
Description:	The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.
Words:	1
Cycles:	1
Example:	`MOVF FSR, 0`

After Instruction
W = value in FSR register
Z = 1

TABLE 39-9: PLL SPECIFICATIONS

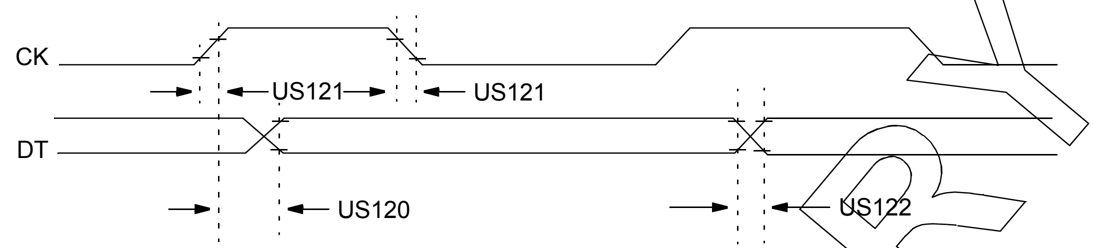
Standard Operating Conditions (unless otherwise stated) VDD ≥ 2.5V							
Param. No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
PLL01	FPLLIN	PLL Input Frequency Range	4	—	8	MHz	
PLL02	FPLLOUT	PLL Output Frequency Range	16	—	32	MHz	**Note 1**
PLL03	TPLLST	PLL Lock Time from Start-up	—	200	—	μs	
PLL04	FPLLJIT	PLL Output Frequency Stability (Jitter)	-0.25	—	0.25	%	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The output frequency of the PLL must meet the FOSC requirements listed in Parameter D002.

FIGURE 39-15: EUSART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

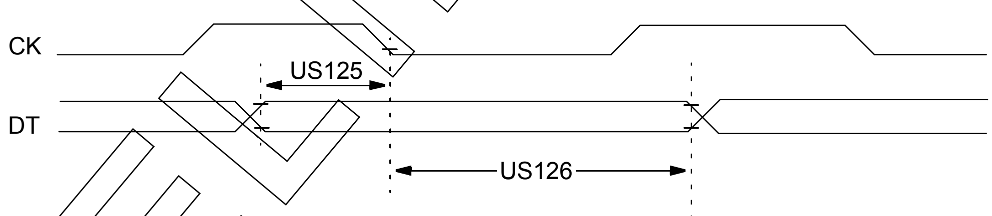


Note: Refer to Figure 39-4 for load conditions.

TABLE 39-22: EUSART SYNCHRONOUS TRANSMISSION CHARACTERISTICS

Standard Operating Conditions (unless otherwise stated)						
Param. No.	**Symbol**	**Characteristic**	**Min.**	**Max.**	**Units**	**Conditions**
US120	TCKH2DTV	SYNC XMIT (Master and Slave) Clock high to data-out valid	—	80	ns	3.0V ≤ VDD ≤ 5.5V
			—	100	ns	1.8V ≤ VDD ≤ 5.5V
US121	TCKRF	Clock out rise time and fall time (Master mode)	—	45	ns	3.0V ≤ VDD ≤ 5.5V
			—	50	ns	1.8V ≤ VDD ≤ 5.5V
US122	TDTRF	Data-out rise time and fall time	—	45	ns	3.0V ≤ VDD ≤ 5.5V
			—	50	ns	1.8V ≤ VDD ≤ 5.5V

FIGURE 39-16: EUSART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING



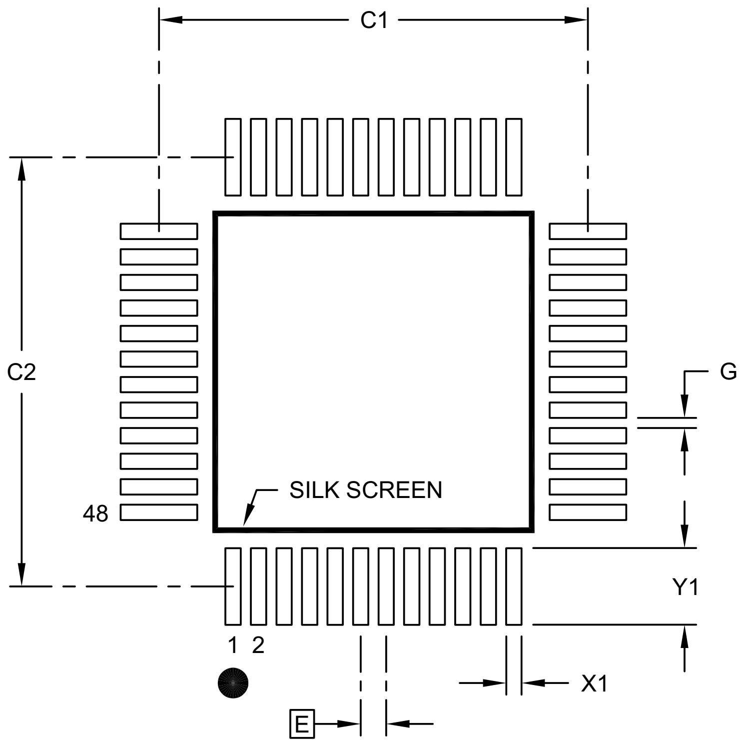
Note: Refer to Figure 39-4 for load conditions.

TABLE 39-23: EUSART SYNCHRONOUS RECEIVE REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)						
Param. No.	**Symbol**	**Characteristic**	**Min.**	**Max.**	**Units**	**Conditions**
US125	TDTV2CKL	SYNC RCV (Master and Slave) Data-setup before CK ↓ (DT hold time)	10	—	ns	
US126	TCKL2DTL	Data-hold after CK ↓ (DT hold time)	15	—	ns	

48-Lead Thin Quad Flatpack (PT) - 7x7x1.0 mm Body [TQFP]

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		8.40	
Contact Pad Spacing	C2		8.40	
Contact Pad Width (X48)	X1			0.30
Contact Pad Length (X48)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2300-PT Rev A

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	[X][1]	- X	/XX	XXX
Device	Tape and Reel Option	Temperature Range	Package	Pattern

Device: PIC16F19155, PIC16(L)F19155
PIC16F19156, PIC16(L)F19156
PIC16F19175, PIC16(L)F19175
PIC16F19176, PIC16(L)F19176
PIC16F19185, PIC16(L)F19185
PIC16F19186, PIC16(L)F19186

Tape and Reel Option:
Blank = Standard packaging (tube or tray)
T = Tape and Reel[1]

Temperature Range:
I = -40°C to +85°C (Industrial)
E = -40°C to +125°C (Extended)

Package:[2]
SS = 28-lead SSOP
SO = 28-lead SOIC
SP = 28-lead SPDIP
MV = 28-lead UQFN
P = 40-lead PDIP
MV = 40-lead UQFN
PT = 44-lead TQFP
MV = 48-lead UQFN
PT = 48-lead TQFP

Pattern: QTP, SQTP, Code or Special Requirements (blank otherwise)

Examples:

a) PIC16(L)F19185/86 - I/PT
Industrial temperature
TQFP package

Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

2: Small form-factor packaging options may be available. Please check www.microchip.com/packaging for small-form factor package availability, or contact your local Sales Office.